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## Vishay General Semiconductor

COMPLIANT

HALOGEN FREE

## **Surface Mount Ultrafast Plastic Rectifier**



**DO-214AC (SMA)** 

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	1.0 A				
V <sub>RRM</sub>	100 V, 150 V, 200 V				
I <sub>FSM</sub>	30 A				
t <sub>rr</sub>	15 ns				
V <sub>F</sub> at I <sub>F</sub> = 1.0 A	0.76 V				
T <sub>J</sub> max.	150 °C				
Package	DO-214AC (SMA)				
Diode variations	Single die				

#### **FEATURES**

- Oxide planar chip junction
- Ultrafast recovery time
- Low forward voltage, low power losses
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **TYPICAL APPLICATIONS**

For use in low voltage, high frequency rectifier of switching power supplies, freewheeling diodes, DC/DC converters or polarity protection application.

#### **MECHANICAL DATA**

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	U1B	U1C	U1D	UNIT
Device marking code		U1B	U1C	U1D	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	150	200	V
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub>	1.0			Α
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30			А
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to + 150			°C



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 0.6 A	T <sub>A</sub> = 25 °C		0.82	0.87	V
	I <sub>F</sub> = 1.0 A	1A = 23 C	V <sub>F</sub> (1)	0.87	0.92	
	I <sub>F</sub> = 0.6 A	T <sub>Δ</sub> = 100 °C		0.71	0.78	
	I <sub>F</sub> = 1.0 A	1A = 100 C		0.76	0.84	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	5.0	μΑ
		T <sub>A</sub> = 100 °C		55	100	
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	T <sub>A</sub> = 25 °C	t <sub>rr</sub>	-	15	ns
	I <sub>F</sub> = 0.6 A, dI/dt = 50 A/μs, V <sub>R</sub> = 30 V, I <sub>rr</sub> = 0.1 I <sub>RM</sub>	T <sub>A</sub> = 25 °C		24	-	
		T <sub>A</sub> = 100 °C		29	-	
Storage charge	$I_F = 0.6 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$	T <sub>A</sub> = 25 °C	Q <sub>rr</sub>	7	-	nC
		T <sub>A</sub> = 100 °C		13	-	
Typical junction capacitance	4.0 V, 1 MHz		CJ	6.8	-	pF

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width ≤ 40 ms

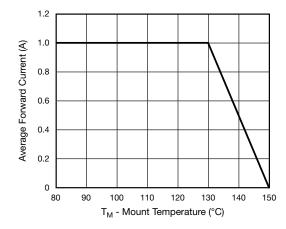
THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	U1B U1C U1D UN			
Typical thormal registance	R <sub>0JA</sub> (1)	115			°C/W
Typical thermal resistance	R <sub>0JM</sub> (1)		22		] C/VV

#### Note

(1) Free air, mounted on recommended copper pad area

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
U1D-M3/61T	0.064	61T	1800	7" diameter plastic tape and reel	
U1D-M3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel	

## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)





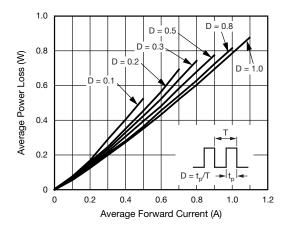


Fig. 2 - Forward Power Loss Characteristics



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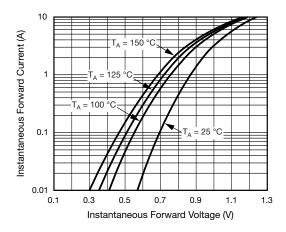


Fig. 3 - Typical Instantaneous Forward Characteristics

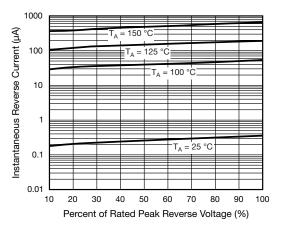


Fig. 4 - Typical Reverse Characteristics

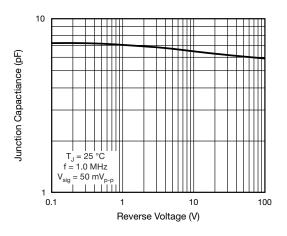


Fig. 5 - Typical Junction Capacitance

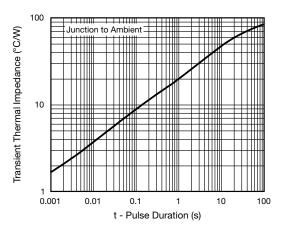
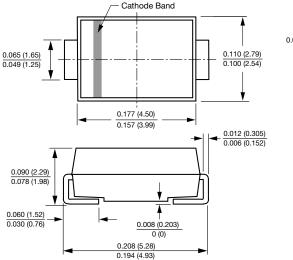
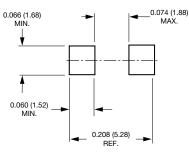


Fig. 6 - Typical Transient Thermal Impedance

# PACKAGE OUTLINE DIMENSIONS in inches (millimeters) DO-214AC (SMA)



## **Mounting Pad Layout**





## **Legal Disclaimer Notice**

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